HINDU COLLEGE, GUNTUR DEPT. OF PHYSICS ADDON COURSE ON CELL PHONE REPAIR

S.NO	NAME OF THE STUDENT	SIGNATURE		
1.	A.ABHISHEK BABU	A-ABHISHER BABU		
2.	A.NIRMAL BABU	A. Nirand Babl		
3.	A.SALOMAN	A. Saloyan		
4.	D.VIJAY	O. VIAY		
5.	G.VENU GOPAL	a, venu aopal		
6.	K.ASHOK	K. Ashok.		
7.	K.DANAM	KDANAM		
8.	K.PRASAD	K. PJabal		
9.	M.BOBBY	M. Bobby		
10.	L.SRUTHI	L. Senthi		
11.	P.POOJITHA	P. Poorifles		
12.	R.SRIRAMU	R.Stigano		
13.	S.VYSHNAVI	S. Vyshav.		
14.	SK.MASTAN VALI	Sk. Mastan Val:		
15.	T.VEERABABU	T- Veerababl		
16.	R.MURALI NAIK	PMURALI NAIK.		
17.	N.PAPARAO	N. Polakas		
18.	M.KONDA GURAVAIAH	M. Konda GURINA'A		
10.				

Module 3 (Software Repair)

Software problems are some of the most common ones faced by smartphone users. Sometimes, a software problem can lead to hardware abnormalities as well. This module will teach you how to perform various software repairing techniques.

- Detailed study of various faults arising due to corrupt software.
- Introduction of various flasher boxes and software.
- Flashing of various brands of handsets.
- > Removing virus from infected phones.
- Unlocking of handsets through codes and/or software.
- Use of various secret codes.

Module 2 (Hardware Repair)

The second module will focus on hardware and teach the students how to handle and replace various electronic parts. It will help them to learn all the hardware repair procedures in a more comprehensive manner.

- Introduction and study of Printed Circuit Board (Motherboard).
- > Details of various components on the PCB.
- Testing of various parts and components.
- Study of different ICs (chips) used on the motherboard.
- > How to recognize various ICs.
- Soldering & desoldering of components by using a soldering iron.
- Soldering & desoldering of components by using a rework station.
- Reheating and mounting of various BGA and SMD chips.
- Ultrasonic cleaning procedure.

Module 1 (Basics and Basic Electronics)

The first module will act as a bridging course for those students who do not have any prior knowledge about the field. For others, who already have prior knowledge about electrical and electronic engineering, this module will help them revise these concepts.

- Basics of mobile communication.
- Study of Digital Electronics.
- Assembling and disassembling of various models of mobile phones.
- Study of various tools and equipment used in mobile phone repairs.
- Study of parts inside a mobile phone.
- > Using a multimeter.
- Use of DC Power Supply (Jhatka machine).

cell phone repair.

Total: 50 Marks.

Assessment test.

Answer any Five questions.

- what are the most common phone repairs.
- what to do before talking phone to repair.
- 3.what is the importance of the phone repairing.
- what are the what to do check after repairing the phone
- what is the maintenance of the cell phone
- what phone is easy to repair.

DEPARTMENT OF PHYSICS

Add on course on Cell phone repairing, assessment scheme

- 1. Each one carries 2 marks.
- 2. Any five points
- 3. For each major 2marks, any five.
- 4. softwares 5 marks, hardware 5 marks.
- 5. For neat maintenance 3marks, softwares3marks, technicalities 4marks.
- 6. For differentiating 5marks,





HINDU COLLEGE, GUNTUR

(Re-accredited by NAAC as Grade 'A' with CGPA 3.07)

DEPARTMENT OF PHYSICS

Certificate of Participation

This is to certify that Mr. / Miss.	Ш		of
Class, Group	has	participated	in
"Cell Phone Repairing" programme organise	d from	n 01-02-2022	to
10-03-2022.			

Head of the Department

Principal

HINDU COLLEGE, GUNTUR DEPT. OF PHYSICS ADDON COURSE ON CELL PHONE REPAIR

S.NO	NAME OF THE STUDENT	MARKS		
1.	A.ABHISHEK BABU	48		
2.	A.NIRMAL BABU	47		
3.	A.SALOMAN	46		
4.	D.VIJAY	47		
5.	G.VENU GOPAL	46		
6.	K.ASHOK	48		
7.	K.DANAM	45		
8.	K.PRASAD	47		
9.	M.BOBBY	48		
10.	L.SRUTHI	47		
11.	P.POOJITHA	48		
12.	R.SRIRAMU	48		
13.	S.VYSHNAVI	49		
14.	SK.MASTAN VALI	47		
15.	T.VEERABABU	47		
16.	R.MURALI NAIK	47		
17.	N.PAPARAO	48		
18. M.KONDA GURAVAIAH		47		